

SM1A25NSK-VB Datasheet

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)			
100	0.124 at V _{GS} = 10 V	4.2	4.6 nC			
100	0.128 at V _{GS} = 4.5 V	3.9	4.0110			

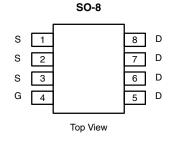
FEATURES

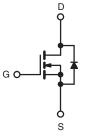
- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

- High Frequency Boost Converter
- LED Backlight for LCD TV







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage		V _{DS}	100	V		
Gate-Source Voltage		V _{GS}	± 20	v		
Continuous Drain Current (T _J = 150 °C)	$T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$	- I _D -	4.2 3.5 3.0 ^{a, b} 2.4 ^{a, b}	A		
Pulsed Drain Current		I _{DM}	16			
Continuous Source-Drain Diode Current	T _C = 25 °C T _A = 25 °C	- I _S -	4.0 2 ^{a, b}			
Single Avalanche Current	L = 0.1 mH		6	A		
Single Avalanche Energy		E _{AS}	1.8	mJ		
Maximum Power Dissipation $T_{C} = 25^{\circ}$ $T_{C} = 70^{\circ}$ $T_{A} = 25^{\circ}$ $T_{A} = 70^{\circ}$		P _D	4.8 3 2.4 ^{a, b} 1.5 ^{a, b}	w		
Operating Junction and Storage Temperatur	T _J , T _{stg}	- 55 to 150	O°			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	42	53	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	21	26	C/W	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under steady state conditions is 85 $^\circ\text{C/W}.$

d. Based on T_C = 25 °C.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	Cymbel			.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	maxi	•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	100			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$			110		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 7.5		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \ \mu A$	1		3	V
Gate-Source Leakage	I _{GSS}	50 60 5 .	•		± 100	nA
	000				1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	10	μA	
On-State Drain Current ^a	I _{D(on)}		8			А
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.7 \text{ A}$		0.124		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 2.5 \text{ A}$				Ω
Forward Transconductance ^a	9 _{fs}					S
Dynamic ^b			I	1	L	
Input Capacitance	C _{iss}			470		pF
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		50		
Reverse Transfer Capacitance	C _{rss}			25		
Tabal Qada Olaama		$V_{DS} = 50$ V, $V_{GS} = 10$ V, $I_{D} = 2.7$ A		7.1	11	
Total Gate Charge	Qg			4.6	7	
Gate-Source Charge	Q _{gs}	V_{DS} = 50 V, V_{GS} = 6 V, I_D = 2.7 A		1.7		nC
Gate-Drain Charge	Q _{gd}			2		
Gate Resistance	Rg	f = 1 MHz		3		Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = 50 V, R_L = 23.8 Ω		10	15	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 2.1 A, V_{GEN} = 6 V, R_g = 1 Ω		10	15	
Fall Time	t _f			10	15	
Turn-On Delay Time	t _{d(on)}			10	15	ns
Rise Time	t _r	V_{DD} = 50 V, R_L = 23.8 Ω		10	15	-
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong\text{2.1}$ A, V_GEN = 10 V, R_g = 1 Ω		12	20	
Fall Time	t _f			10	15	
Drain-Source Body Diode Characteristic	cs		1			1
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			4	•
Pulse Diode Forward Current	I _{SM}				8	A
Body Diode Voltage	V _{SD}	$I_{S} = 2.1 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			50	80	ns
Body Diode Reverse Recovery Charge	Q _{rr}			75	120	nC
Reverse Recovery Fall Time	t _a	$I_F = 2.1 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		28		
Reverse Recovery Rise Time	t _b			22		ns

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

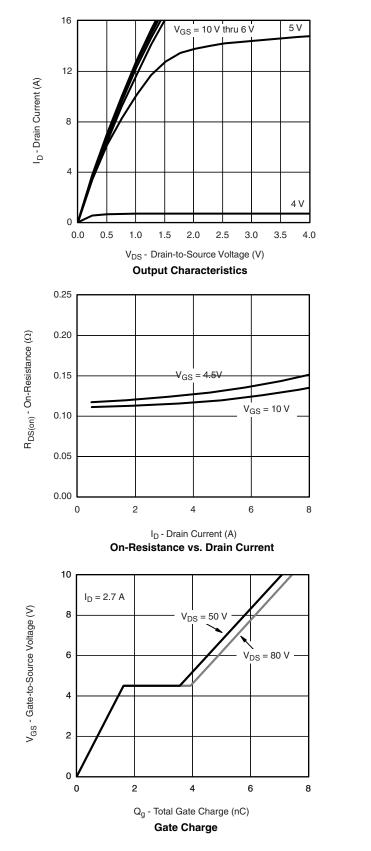
b. Guaranteed by design, not subject to production testing.

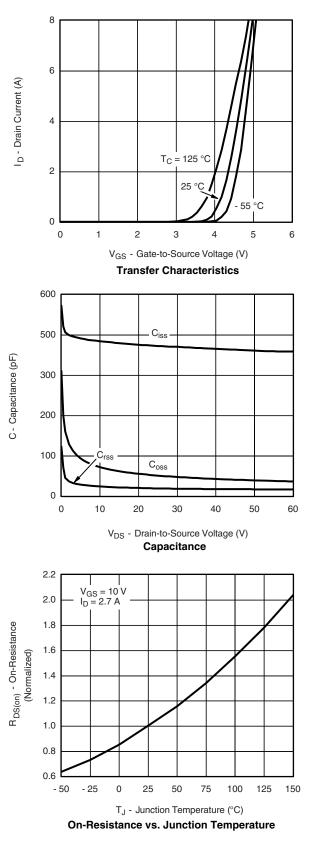
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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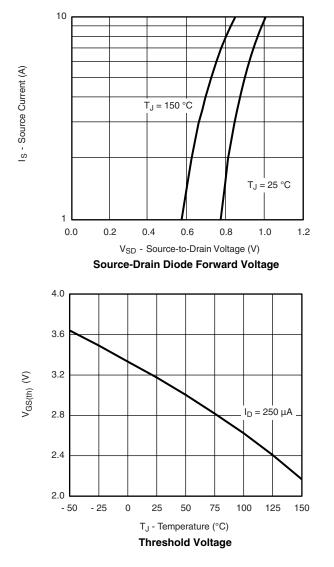
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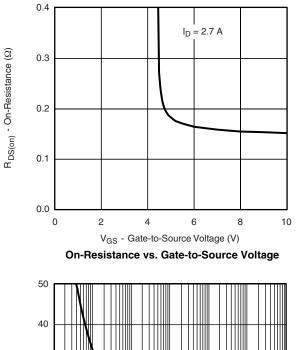


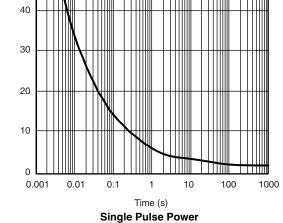


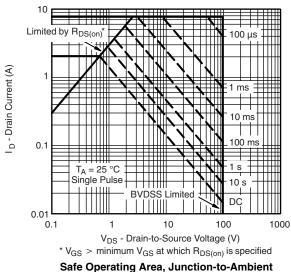






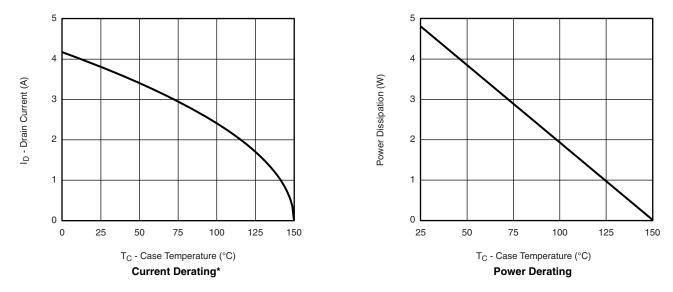






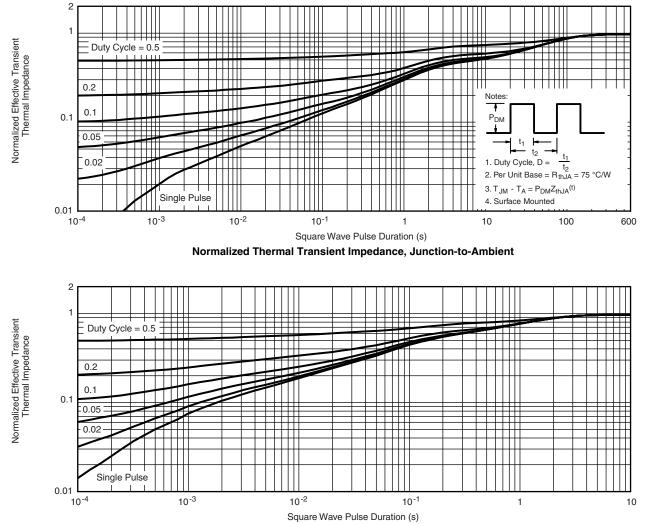
Power (W)





* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



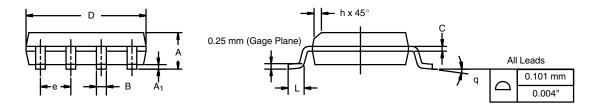


Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012

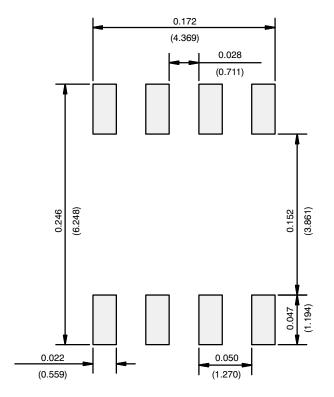




	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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